

## MICROPOWER DUAL CMOS VOLTAGE COMPARATORS

- PUSH-PULL CMOS OUTPUT (NO EXTERNAL PULL-UP RESISTOR REQUIRED)
- EXTREMELY LOW SUPPLY CURRENT :  $9\mu\text{A}$  typ / comparator
- WIDE SINGLE SUPPLY RANGE **2.7V TO 16V** OR DUAL SUPPLIES ( $\pm 1.35\text{V}$  TO  $\pm 8\text{V}$ )
- EXTREMELY LOW INPUT BIAS CURRENT :  $1\text{pA}$  typ
- EXTREMELY LOW INPUT OFFSET CURRENTS :  $1\text{pA}$  typ
- INPUT COMMON-MODE VOLTAGE RANGE INCLUDES GND
- HIGH INPUT IMPEDANCE :  $10^{12}\Omega$  typ
- FAST RESPONSE TIME :  $2\mu\text{s}$  typ for 5mV overdrive
- PIN-TO-PIN AND FUNCTIONALLY COMPATIBLE WITH BIPOLAR LM393

### DESCRIPTION

The TS3702 is a micropower CMOS dual voltage comparator with extremely low consumption of  $9\mu\text{A}$  typ / comparator (20 times less than bipolar LM393). The push-pull CMOS output stage allows power and space saving by eliminating the external pull-up resistor required by usual open-collector output comparators.

Thus response times remain similar to the LM393.

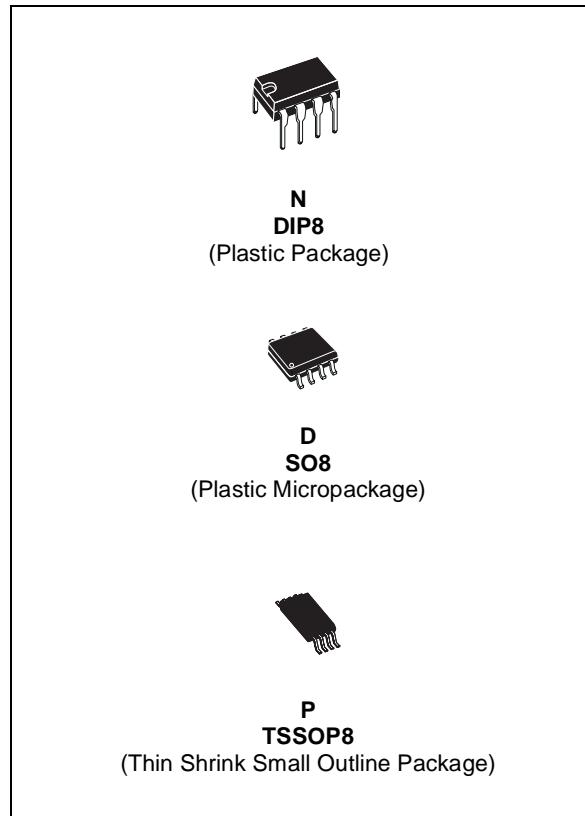
### ORDER CODE

Part Number	Temperature Range	Package		
		N	D	P
TS3702C	$0^\circ\text{C}, +70^\circ\text{C}$	•	•	•
TS3702I	$-40^\circ\text{C}, +125^\circ\text{C}$	•	•	•
TS3702M	$-55^\circ\text{C}, +125^\circ\text{C}$	•	•	•

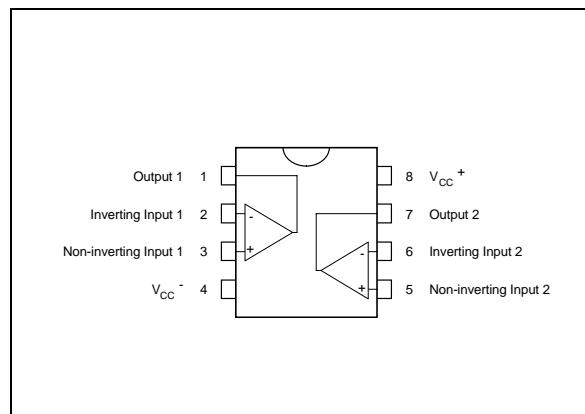
N = Dual in Line Package (DIP)

D = Small Outline Package (SO) - also available in Tape & Reel (DT)

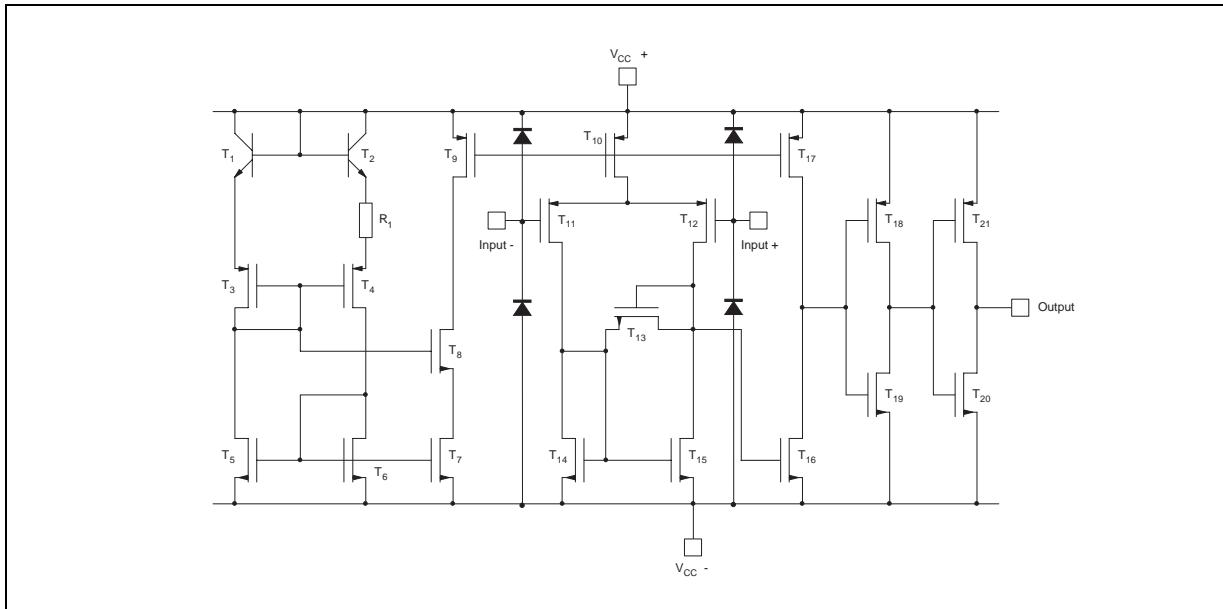
P = Thin Shrink Small Outline Package (TSSOP) - only available in Tape & Reel (PT)



### PIN CONNECTIONS (top view)



## SCHEMATIC DIAGRAM (for 1/2 TS3702)



## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{CC}^+$	Supply Voltage <sup>1)</sup>	18	V
$V_{id}$	Differential Input Voltage <sup>2)</sup>	$\pm 18$	V
$V_i$	Input Voltage <sup>3)</sup>	18	V
$V_o$	Output Voltage	18	V
$I_o$	Output Current	20	mA
$I_F$	Forward Current in ESD Protection Diodes on Input <sup>4)</sup>	50	mA
$P_d$	Power Dissipation <sup>5)</sup> DIP8 SO8 TSSOP8	1250 710 625	mW
$T_{stg}$	Storage Temperature Range	-65 to +150	°C

1. All voltage values, except differential voltage, are with respect to network ground terminal.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
3. The magnitude of the input and the output voltages must never exceed the magnitude of the positive supply voltage.
4. Guaranteed by design.
5.  $P_d$  is calculated with  $T_{amb} = +25^\circ\text{C}$ ,  $T_j = +150^\circ\text{C}$  and  $R_{thja} = 100^\circ\text{C/W}$  for DIP8 package  
 $= 175^\circ\text{C/W}$  for SO8 package  
 $= 200^\circ\text{C/W}$  for TSSOP8 package

## OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
$V_{CC}^+$	Supply Voltage TS3702C,I TS3702M	2.7 to 16 4 to 16	V
$V_{icm}$	Common Mode Input Voltage Range	0 to $V_{CC}^+ - 1.5$	V
$T_{oper}$	Operating Free-Air Temperature range TS3702C TS3702I TS3702M	0 to +70 -40 to +125 -55 to +125	°C

**ELECTRICAL CHARACTERISTICS** $V_{CC}^+ = 3V$ ,  $V_{CC}^- = 0V$ ,  $T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{io}$	Input Offset Voltage <sup>1)</sup> $V_{ic} = 1.5V$ $T_{min} \leq T_{amb} \leq T_{max}$ .			5 6.5	mV
$I_{io}$	Input Offset Current <sup>2)</sup> $V_{ic} = 1.5V$ $T_{min} \leq T_{amb} \leq T_{max}$ .		1	300	pA
$I_{ib}$	Input Bias Current <sup>2)</sup> $V_{ic} = 1.5V$ $T_{min} \leq T_{amb} \leq T_{max}$ .		1	600	pA
$V_{icm}$	Input Common Mode Voltage Range $T_{min} \leq T_{amb} \leq T_{max}$	0 0		$V_{CC}^+ - 1.2$ $V_{CC}^+ - 1.5$	V
CMR	Common-mode Rejection Ratio $V_{ic} = V_{icm} \text{ min.}$		80		dB
SVR	Supply Voltage Rejection Ratio $V_{CC}^+ = 3V \text{ to } 5V$		75		dB
$V_{OH}$	High Level Output Voltage $V_{id} = 1V$ , $I_{OH} = -4mA$ $T_{min} \leq T_{amb} \leq T_{max}$ .	2 1.8	2.4		V
$V_{OL}$	Low Level Output Voltage $V_{id} = -1V$ , $I_{OL} = 4mA$ $T_{min} \leq T_{amb} \leq T_{max}$ .		300	400 450	mV
$I_{cc}$	Supply Current (each comparator) No load - Outputs low $T_{min} \leq T_{amb} \leq T_{max}$ .		7	20 25	µA
$t_{PLH}$	Response Time Low to High $V_{ic} = 0V$ , $f = 10kHz$ , $C_L = 50pF$ , Overdrive = 5mV TTL Input		1.5 0.7		µs
$t_{PHL}$	Response Time High to Low $V_{ic} = 0V$ , $f = 10kHz$ , $C_L = 50pF$ , Overdrive = 5mV TTL Input		2.2 0.15		µs

1. The specified offset voltage is the maximum value required to drive the output up to 2.5V or down to 0.3V.

2. Maximum values including unavoidable inaccuracies of the industrial test.

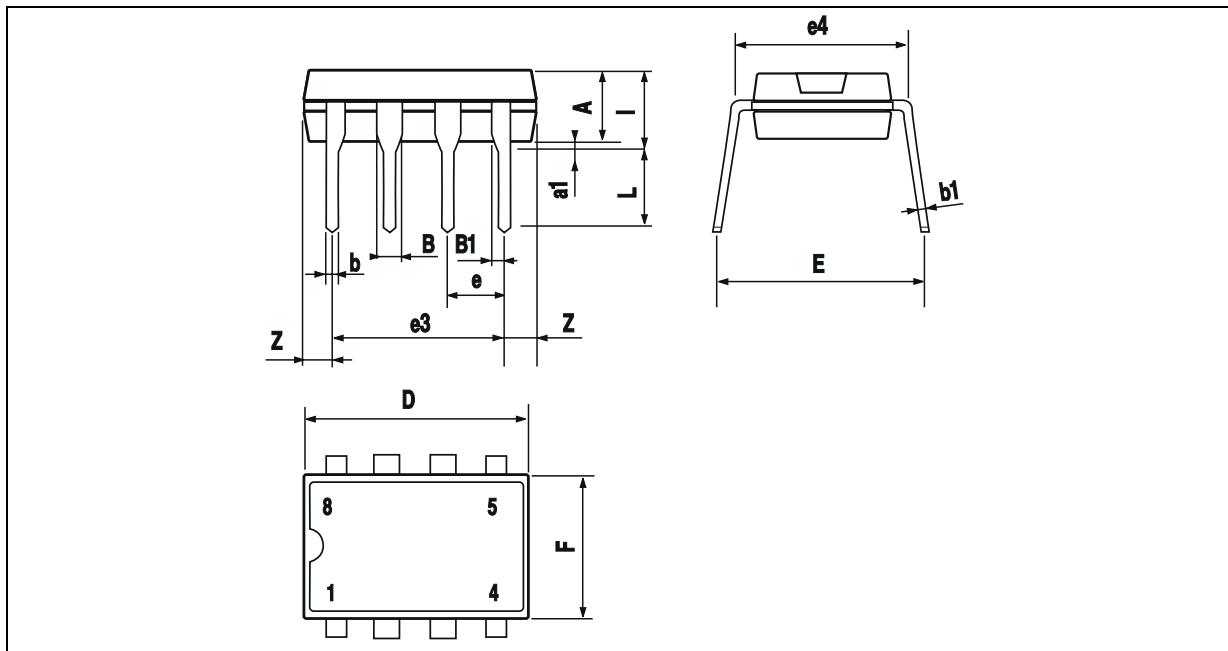
**ELECTRICAL CHARACTERISTICS** $V_{CC}^+ = 5V$ ,  $V_{CC}^- = 0V$ ,  $T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{io}$	Input Offset Voltage $V_{ic} = V_{icm\ min.}, V_{CC}^+ = 5V \text{ to } 10V$ <sup>1)</sup> $T_{min.} \leq T_{amb} \leq T_{max.}$		1.2	5 6.5	mV
$I_{io}$	Input Offset Current <sup>2)</sup> $V_{ic} = 2.5V$ $T_{min.} \leq T_{amb} \leq T_{max.}$		1	300	pA
$I_{ib}$	Input Bias Current <sup>2)</sup> $V_{ic} = 2.5V$ $T_{min.} \leq T_{amb} \leq T_{max.}$		1	600	pA
$V_{icm}$	Input Common Mode Voltage Range $T_{min.} \leq T_{amb} \leq T_{max.}$	0 0		$V_{CC}^+ - 1.2$ $V_{CC}^+ - 1.5$	V
CMR	Common-mode Rejection Ratio $V_{ic} = V_{icm\ min.}$		82		dB
SVR	Supply Voltage Rejection Ratio $V_{CC}^+ = +5V \text{ to } +10V$		90		dB
$V_{OH}$	High Level Output Voltage $V_{id} = 1V, I_{OH} = -4mA$ $T_{min.} \leq T_{amb} \leq T_{max.}$	4.5 4.3	4.7		V
$V_{OL}$	Low Level Output Voltage $V_{id} = -1V, I_{OL} = 4mA$ $T_{min.} \leq T_{amb} \leq T_{max.}$		200	300 375	mV
$I_{cc}$	Supply Current (each comparator) No load - Outputs low $T_{min.} \leq T_{amb} \leq T_{max.}$		9	20 25	µA
$t_{PLH}$	Response Time Low to High $V_{ic} = 0V, f = 10kHz, C_L = 50pF,$ Overdrive = 5mV Overdrive = 10mV Overdrive = 20mV Overdrive = 40mV TTL Input		1.5 1.1 0.9 0.7 0.6		µs
$t_{PHL}$	Response Time High to Low $V_{ic} = 0V, f = 10kHz, C_L = 50pF,$ Overdrive = 5mV Overdrive = 10mV Overdrive = 20mV Overdrive = 40mV TTL Input		2.2 1.6 1.1 0.75 0.17		µs
$t_f$	Fall time $f = 10kHz, C_L = 50pF, \text{ Overdrive } 50mV$		30		ns

1. The specified offset voltage is the maximum value required to drive the output up to 4.5V or down to 0.3V.

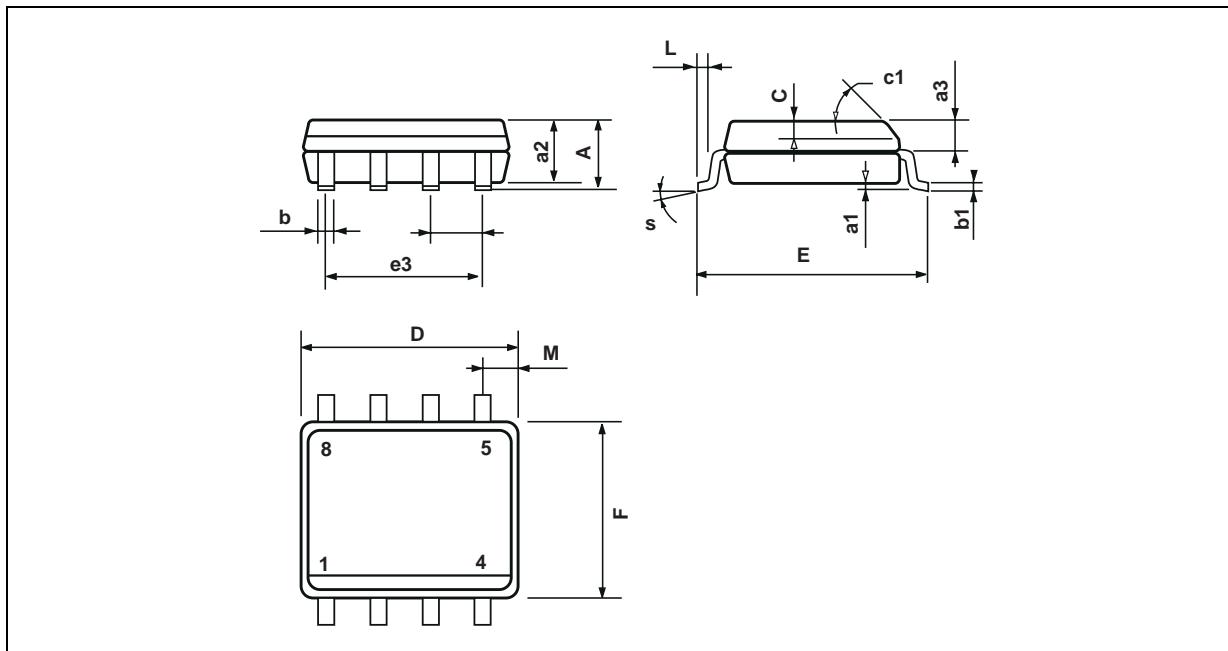
2. Maximum values including unavoidable inaccuracies of the industrial test.

**PACKAGE MECHANICAL DATA**  
8 PINS - PLASTIC DIP



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.32			0.131	
a1	0.51			0.020		
B	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D		10.92				0.430
E	7.95		9.75	0.313		0.384
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
i			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

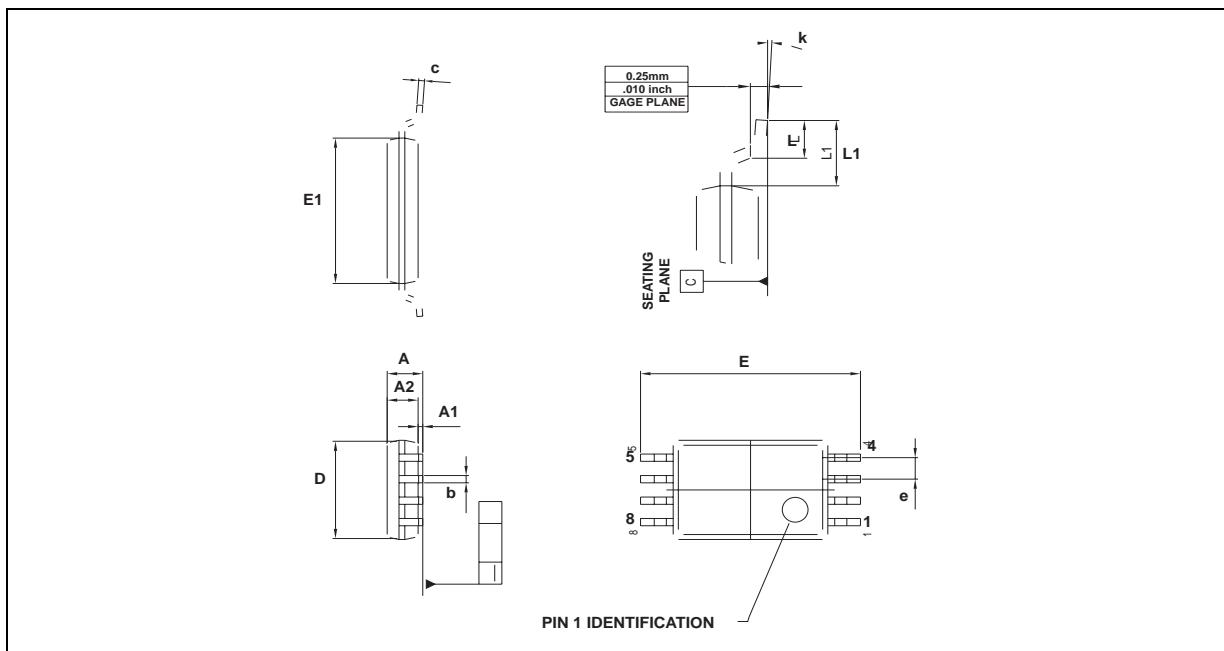
**PACKAGE MECHANICAL DATA**  
8 PINS - PLASTIC MICROPACKAGE (SO)



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
a3	0.65		0.85	0.026		0.033
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.020
c1	45° (typ.)					
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.150		0.157
L	0.4		1.27	0.016		0.050
M			0.6			0.024
S	8° (max.)					

## PACKAGE MECHANICAL DATA

8 PINS - THIN SHRINK SMALL OUTLINE PACKAGE (TSSOP)



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.20			0.05
A1	0.05		0.15	0.01		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.15
c	0.09		0.20	0.003		0.012
D	2.90	3.00	3.10	0.114	0.118	0.122
E		6.40			0.252	
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.025	
k	0°		8°	0°		8°
I	0.50	0.60	0.75	0.09	0.0236	0.030
L	0.45	0.600	0.75	0.018	0.024	0.030
L1		1.000			0.039	

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